SBR1A40SA

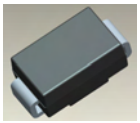
1.0A SBR®
SUPER BARRIER RECTIFIER
SMA

Features

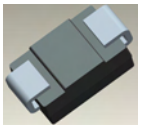
- Low Leakage Current
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150ºC Operating Junction Temperature
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **Green Molding Compound (No Halogen and Antimony) (Note 2)**

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish.) Solderable per MIL-STD-202, Method 208 e3
- Polarity Indicator: Cathode Band
- Weight: 0.064 grams (approximate)



Top View



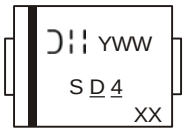
Bottom View

Ordering Information (Note 3)

Part Number	Case	Packaging
SBR1A40SA-13	SMA	5000/Tape & Reel

Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
2. No purposefully added lead. Halogen and Antimony Free.
3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



S D 4 = Product Type Marking Code
= Manufacturers' code marking
YWW = Date Code Marking
Y = Last digit of year (ex: 9 for 2009)
WW = Week code (01 - 53)

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Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_{RM}	40	V
Average Rectified Output Current (See Figure 1)	I_O	1	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	25	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 4)	$R_{\theta JA}$	116	ºC/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	ºC

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V_F	-	- -	0.5 0.45	V	I_F = 1.0A, T_J = 25ºC I_F = 1.0A, T_J = 125ºC
Leakage Current (Note 5)	I_R	-	- -	500 100	µA mA	V_R = 40V, T_J = 25ºC V_R = 40V, T_J = 100ºC

Notes: 4. Device mounted on Polymide substrate, with 1" x 1", 2 oz. Copper, double-sided PCB board.
5. Short duration pulse test used to minimize self-heating effect.

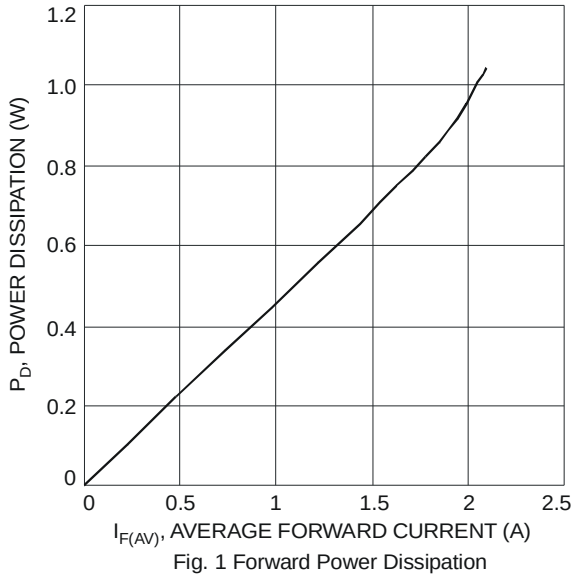

Fig. 1 Forward Power Dissipation

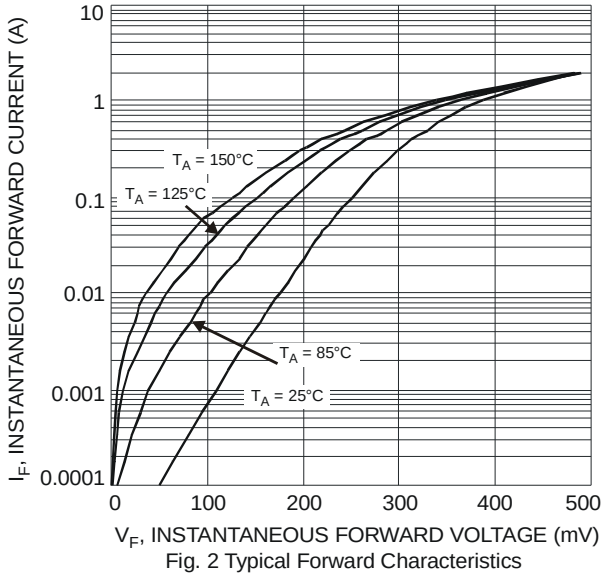

Fig. 2 Typical Forward Characteristics

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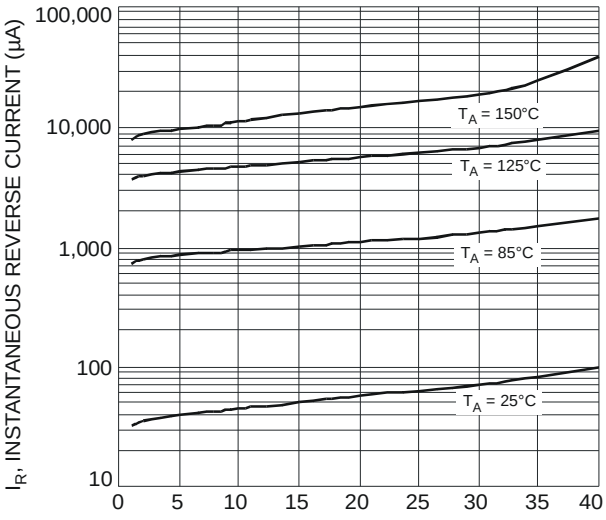


Fig. 3 Typical Reverse Characteristics

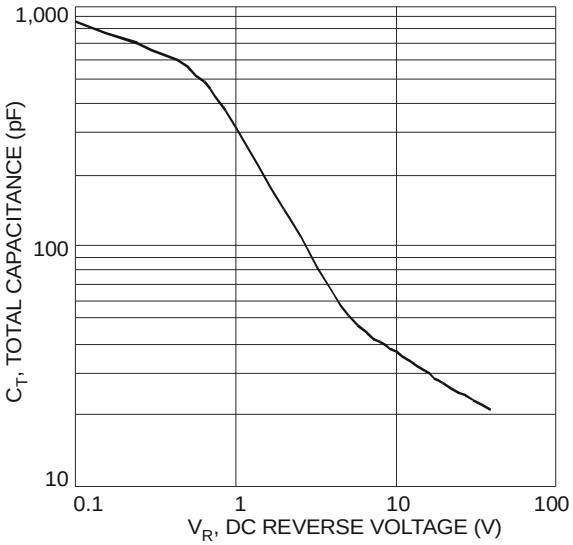


Fig. 4 Total Capacitance vs. Reverse Voltage

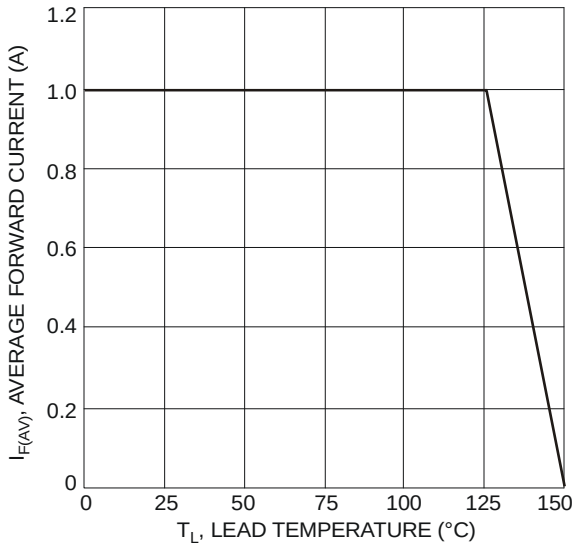


Fig. 5 Forward Current Derating Curve

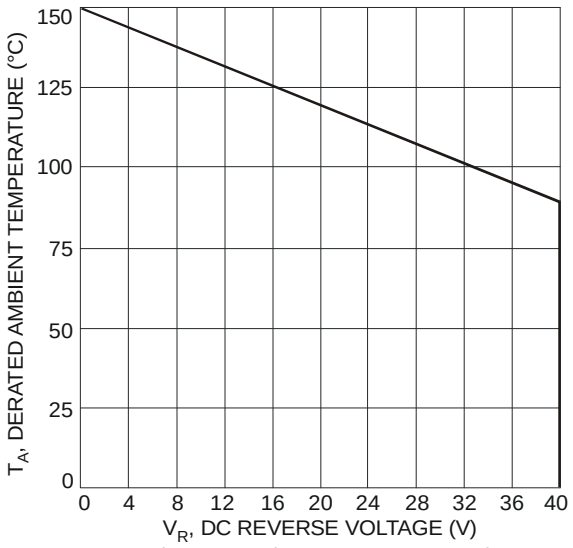
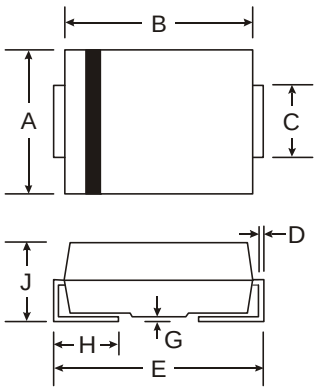


Fig. 6 Operating Temperature Derating

Package Outline Dimensions



SMA		
Dim	**Min**	**Max**
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
H	0.76	1.52
J	2.01	2.30
All Dimensions in mm		

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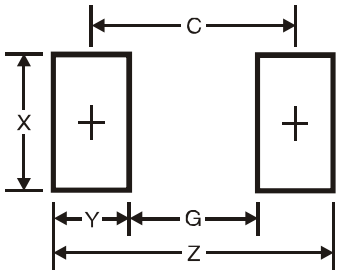
Suggested Pad Layout



Dimensions	Value (in mm)
Z	6.5
G	1.5
X	1.7
Y	2.5
C	4.0